

Fig. 1(a)

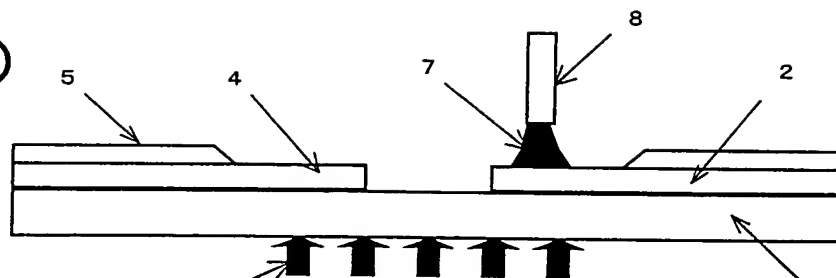


Fig. 1(b)

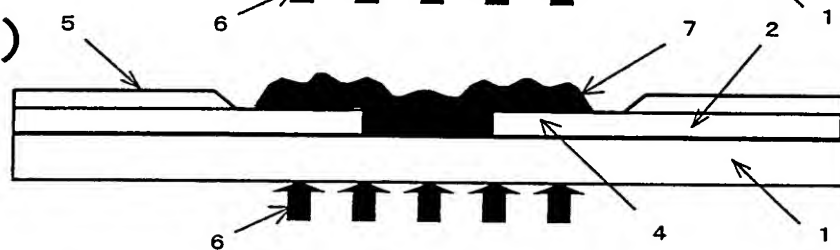


Fig. 1(c)

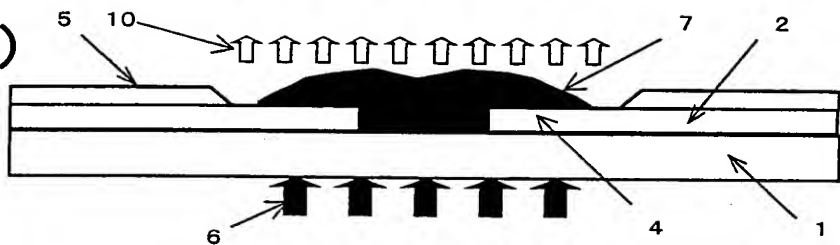


Fig. 1(d)

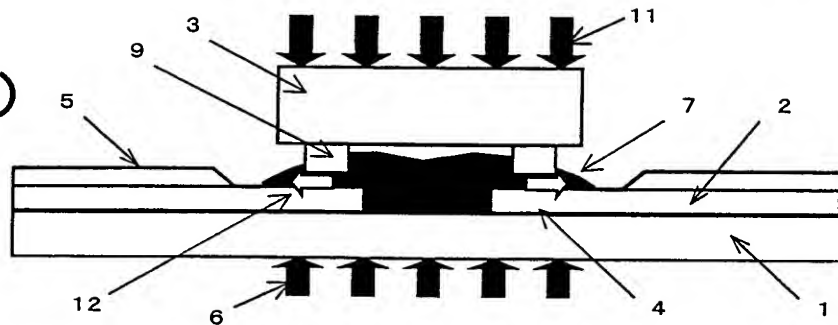
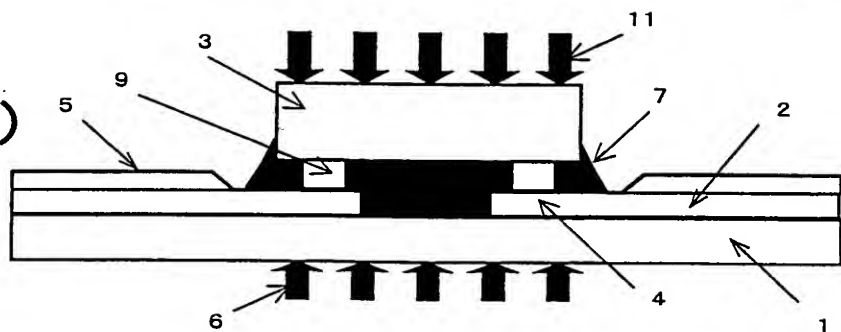


Fig. 1(e)



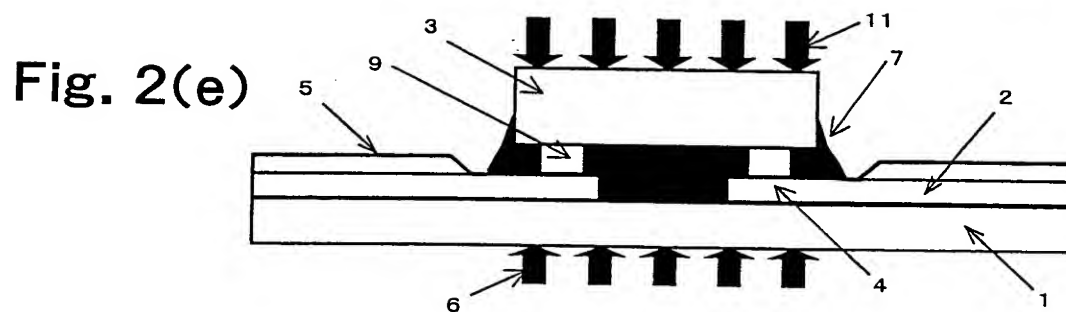
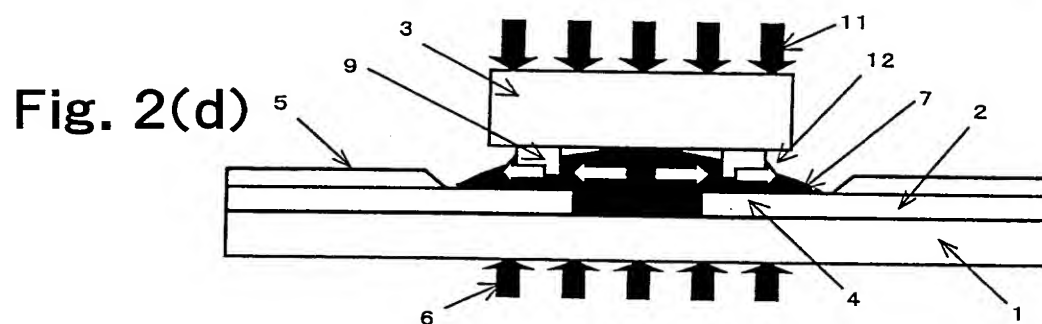
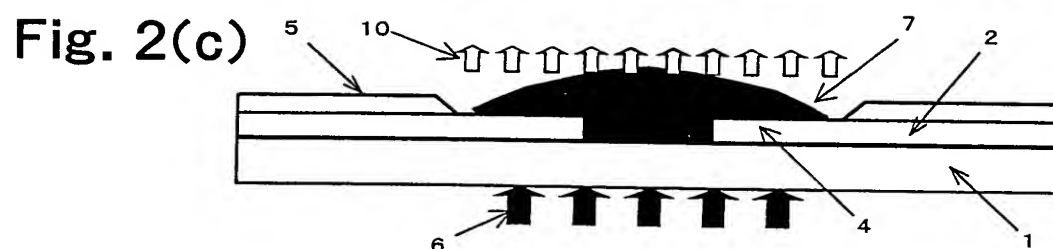
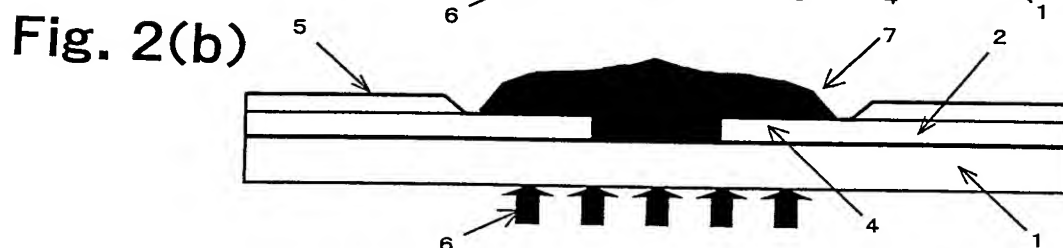
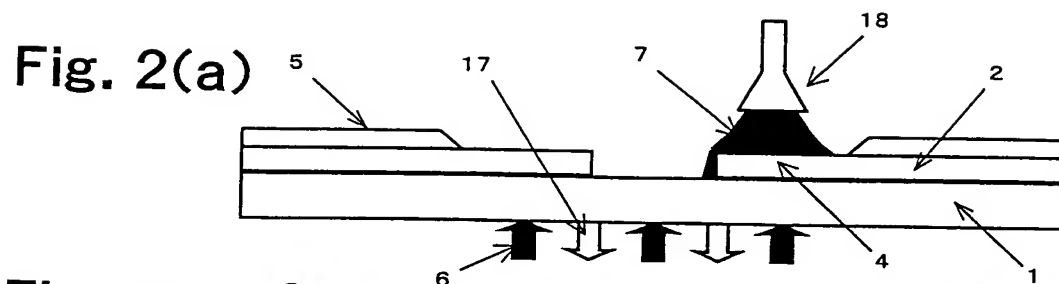


Fig. 3

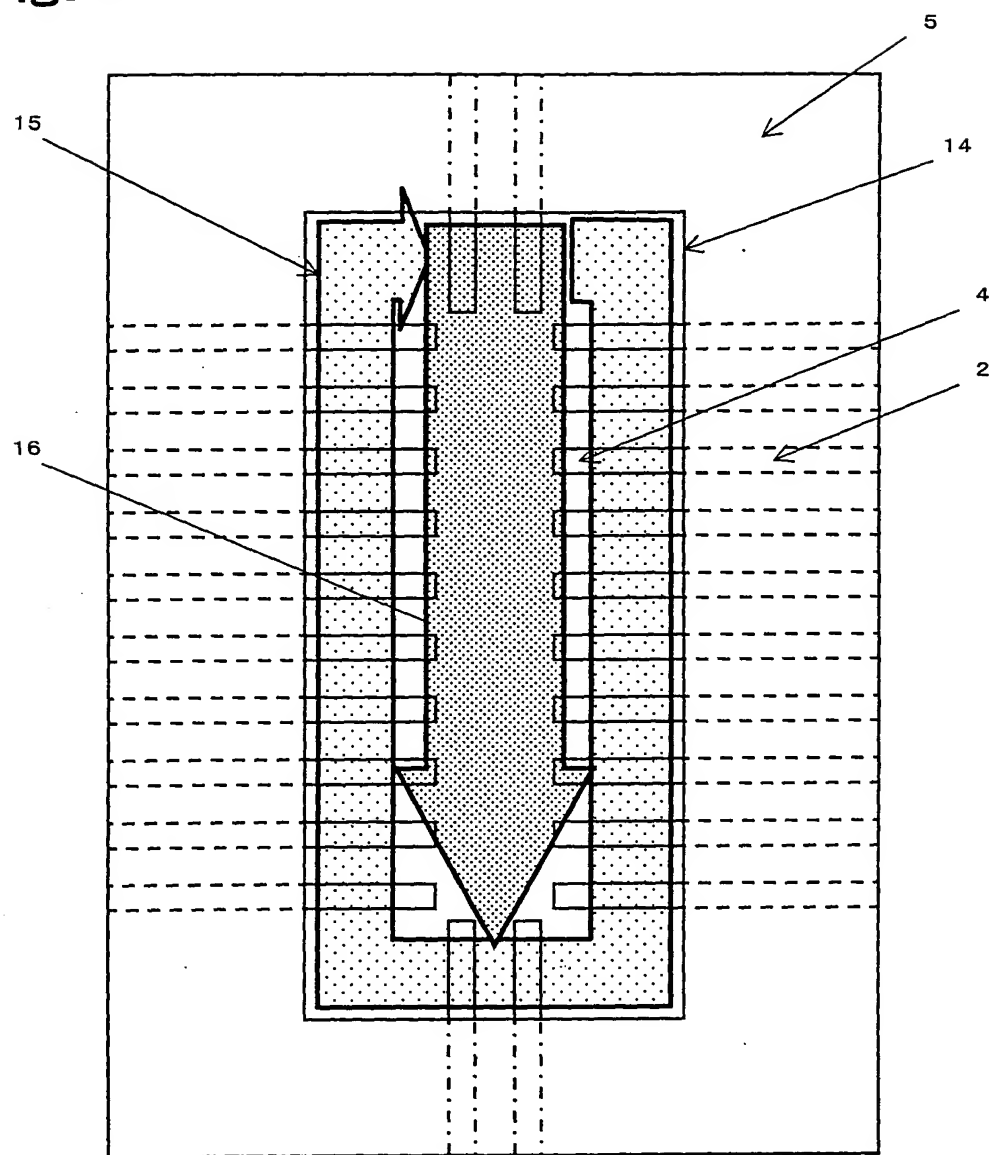


Fig. 4(a)

Fig. 4(a) is a cross-sectional view of a device. It shows a substrate 1 with a layer 2 on top. A structure 19 is formed on layer 2, consisting of a base 20 and a top part 18. A layer 5 is on the left, and a layer 17 is on the right. Arrows 6 point upwards from the substrate 1 towards the structure 19. Arrows 4 point downwards from the structure 19 towards the substrate 1. Arrows 1 and 2 point to the substrate and layer 2 respectively.

Fig. 4(b)

Fig. 4(b) is a cross-sectional view of the device after the second step. It shows the substrate (1) with a thin layer (2) and a thicker layer (4). A central region (20) is filled with a material containing white dots. Arrows (6) point upwards from below the substrate, indicating a process like deposition or curing. Labels 1, 2, 4, 5, 6, 19, and 20 are present.

[illegible][illegible]

Fig. 4(e)

Fig. 5(a)
Prior Art

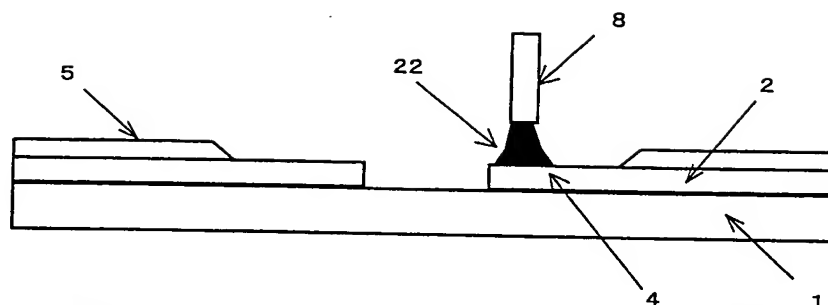


Fig. 5(b)
Prior Art

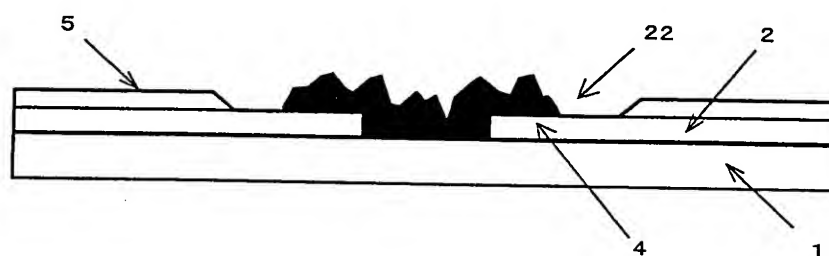


Fig. 5(c)
Prior Art

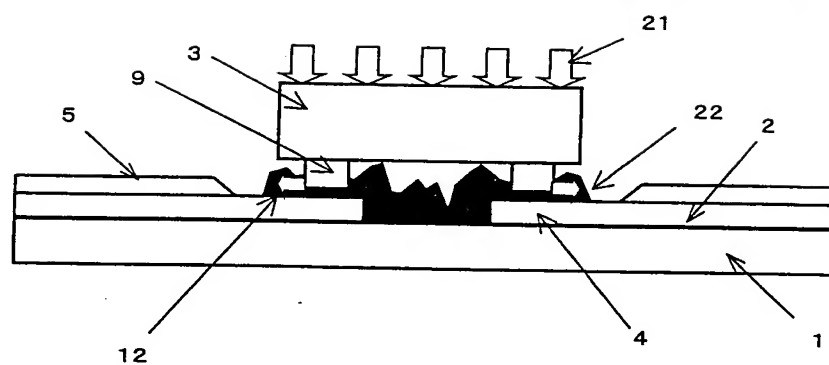


Fig. 5(d)
Prior Art

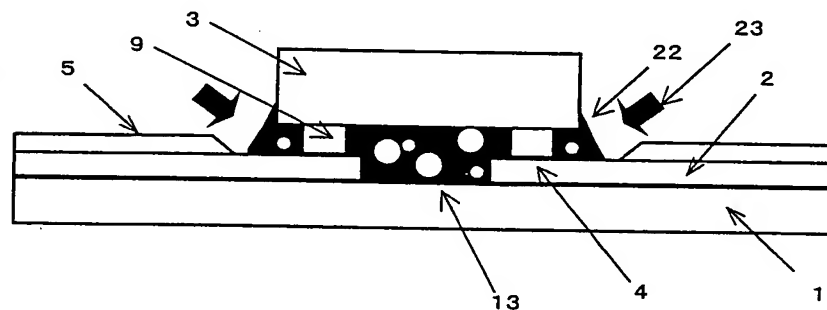


Fig. 6(a)
Prior Art

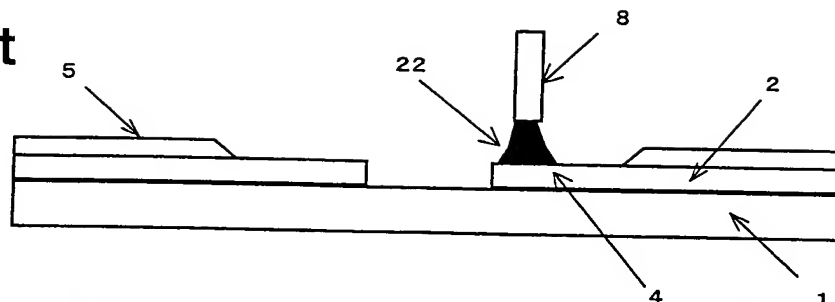


Fig. 6(b)
Prior Art

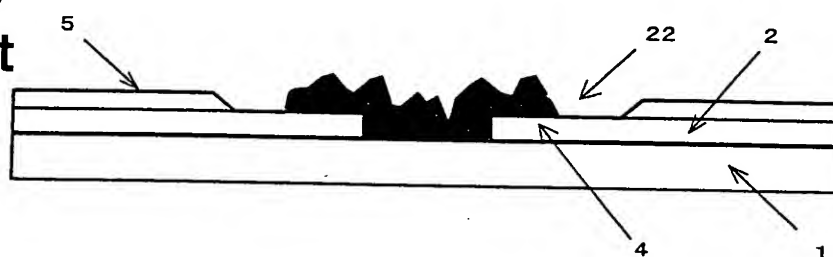


Fig. 6(c)
Prior Art

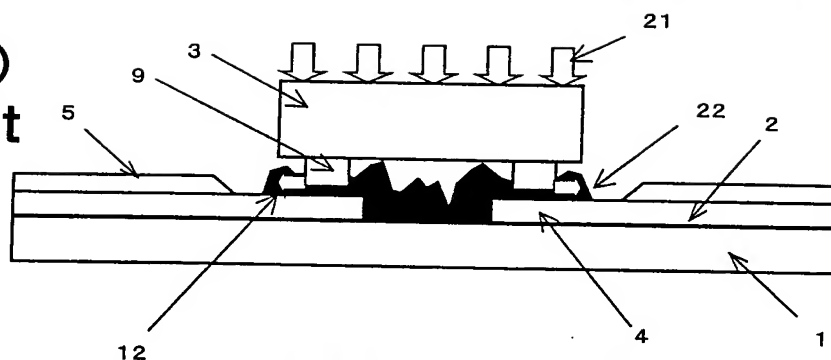


Fig. 6(d)
Prior Art

